











PORT_3_EST1					
11	EST1	EST1	EST1	EST1	EST1
12	EST2	EST2	EST2	EST2	EST2
13	EST3	EST3	EST3	EST3	EST3
14	EST4	EST4	EST4	EST4	EST4
15	EST5	EST5	EST5	EST5	EST5

PORT_1					
11	EST1	EST1	EST1	EST1	EST1
12	EST2	EST2	EST2	EST2	EST2
13	EST3	EST3	EST3	EST3	EST3
14	EST4	EST4	EST4	EST4	EST4
15	EST5	EST5	EST5	EST5	EST5

PORT_2					
11	EST1	EST1	EST1	EST1	EST1
12	EST2	EST2	EST2	EST2	EST2
13	EST3	EST3	EST3	EST3	EST3
14	EST4	EST4	EST4	EST4	EST4
15	EST5	EST5	EST5	EST5	EST5

PORT_3					
11	EST1	EST1	EST1	EST1	EST1
12	EST2	EST2	EST2	EST2	EST2
13	EST3	EST3	EST3	EST3	EST3
14	EST4	EST4	EST4	EST4	EST4
15	EST5	EST5	EST5	EST5	EST5

PORT_4					
11	EST1	EST1	EST1	EST1	EST1
12	EST2	EST2	EST2	EST2	EST2
13	EST3	EST3	EST3	EST3	EST3
14	EST4	EST4	EST4	EST4	EST4
15	EST5	EST5	EST5	EST5	EST5

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